



Cleaning Systems for Electronic and Semiconductor Industries

Printing Applications

- Stencils
- Mesh screens
- Squeegees
- Misprints

Solder paste, SMT Adhesive, Flux, Conductive ink, Solder Balls...

SMT, THT Applications

- PCBA
- PCB
- Ceramic Substrates
- COB

Flux, Solder paste, Coating, Dust and Soil deposit...

Semiconductor Applications

- Silicon Wafers
- Lead-frames
- Power Modules
- DCB

Flux, Surface oxidation...

Maintenance Applications

- Solder carriers
- Oven condensers
- Coating carriers
- Printing heads

Flux, Coating, Dust and Soil deposit, Solder paste...

N29 E: Patented filtration and US cleaning + hot air drying (from 5 to 9 stencils per day)

N29 SA4: N29 E + automatic stencil lift (from 10 to 30 stencils per day)

N29 AUTO: Patented filtration, US and/or SUI, hot air drying, full auto (from 10 to 30 stencils per day)

N29 HV: High volume automatic stencil cleaner with all MBtech technologies built in!

NC25 E: 3 stages water based process, closed loop patented filtration, zero discharge, for small to mid-volumes (Clean SUI/Rinse/Vacuum Dry)

NC25: 4 stages water based or semi water based process, closed loop patented filtration, zero discharge for mid to high volumes (Clean SUI/Rinse/Final Rinse/Vacuum Dry)

NC25 AL: NC25 with automatic loading unloading system

MC200: single chamber spray in air process (Clean/Dry)

MC200+: MC200 with Rinse stage and multi spray arms

MC200PF: MC200 for printing heads with Air knife arm

MC10: 3 stages, closed loop, zero discharge, (Clean US/Rinse/ Dry)

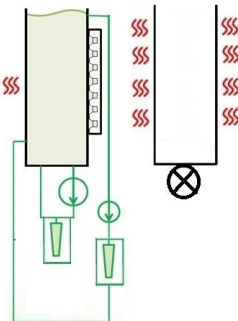
BNC8000: Pick and Place Nozzle Cleaner



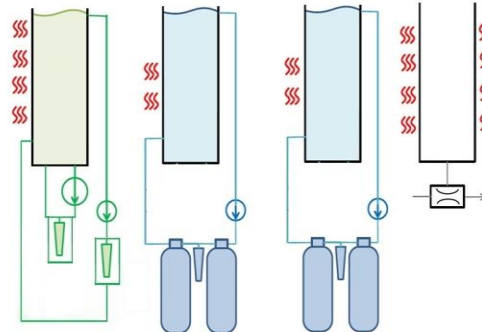
N29AUTO



N29SA4



N29HV & NC25



MC200

A dynamic splash of clear water moving from left to right across the lower half of the page, with numerous droplets and ripples.

MBtech

your cleaning partner

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